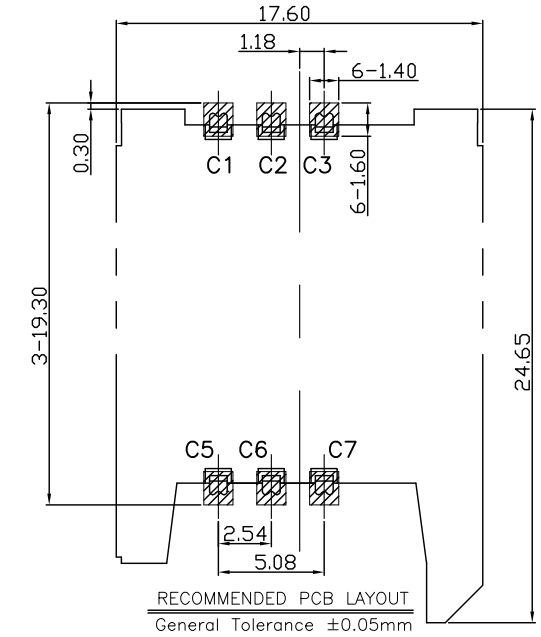
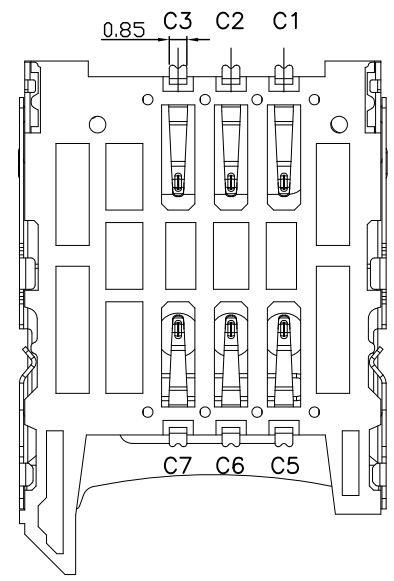
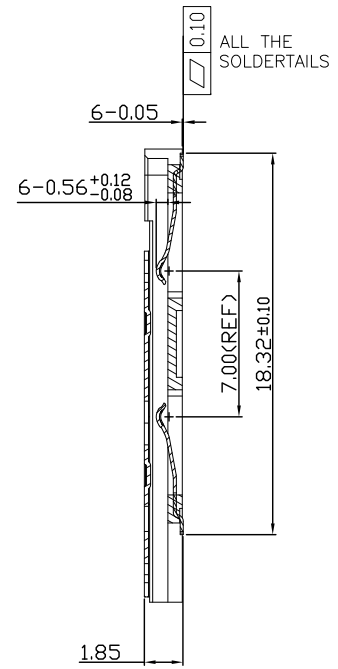
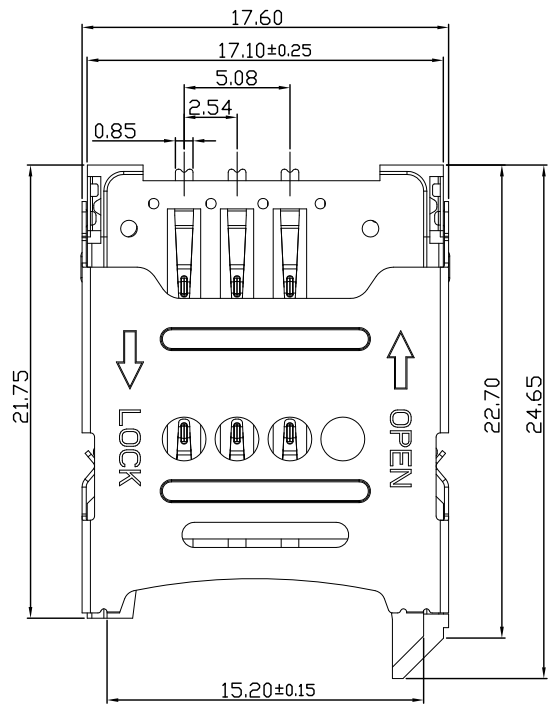
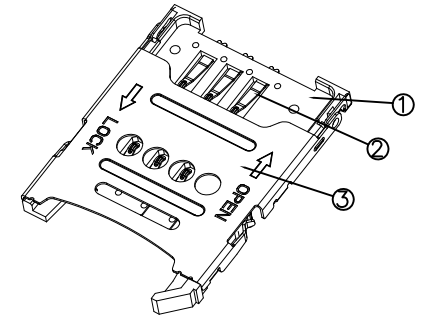
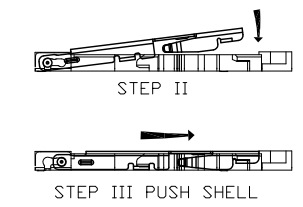
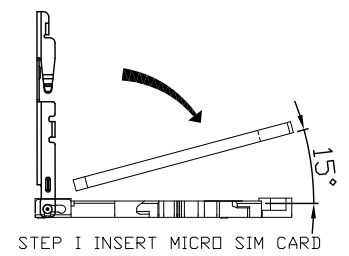
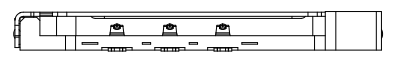


REV.	ECN.NO.	MODIFY.CONTENT
A	/	NEW

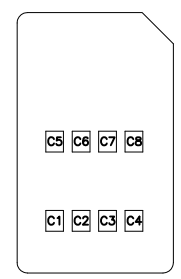


- NOTES:
- 1.ELECTRICAL CHARACTERISTICS:
1-1.RATED CURRENT:1A MAX
1-2.VOLTAGE RATING:50V AC MAX
1-3.CONTACT RESISTANCE:
50m ΩMAX(INITIAL);
100m ΩMAX(FINAL)
1-4.DIELECTRIC WITHSTANDING VOLTAGE:
500V AC FOR ONE MINUTE.
1-5.INSULATION RESISTANCE:
1000M Ω MIN. MEASUTED BY 500V DC
 - 2.DURABILITY TEST:1,000 CYCLES.
 - 3.FOR REFLOW SOLDERING LEAD-FREE PROCESS.
 - 4.SOLDERING HEAT RESISTANCE
REFLOW SOLDERING 250C..
 - 5.PACKAGING: TAPE&REEL.
 - 6.PRODUCT SHOULD COMPLY WITH ROHS REQUIREMENT

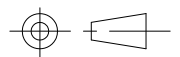


PIN ASSIGNMENTS:

PIN NO	C1	C2	C3	C5	C6	C7
FUNCTION	VCC	RST	CLK	GND	VPP	I/O



③	SHELL	1set	STAINLESS STEEL 0.2T	Cleaning
②	CONTACT	1pcs	COPPER ALLOY 0.15T	Contact area Au 1u"Min,Solder area Tin 80u"Min, All Over 80u"Min Ni
①	HOUSING	1pcs	HIGH TEMP PLASTIC	UL94V-0, COLOR: BLACK
ITEM	DESCRIPTION	Q'TY	MATERIAL	FINISH

GENERAL	TOLERANCE	DWG.NO.	SP115-AN401-**	PART.NO.	SP115-AN401-28	DRAWN	GONG 2018.09.05	UNIT	mm	SCALE	1:1
x.±0.50	x.*± 5°	REV.	A	TITLE	1.85mmH Flip Sim Card conn.	CHECKED		 东莞市欧联电子科技有限公司 DONGGUAN OLN ELECTRONICS TECHNOLOGY CO., LTD.			
.x±0.25	.x*± 2°	SIZE		SHEET	1 OF 2	APPROVED					
.xx±0.15	.xx± 1°	A4									